

**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Previously Presented) The pretreatment method according to claim 19, removing contaminants on the surface of the metal sample by sputtering occurs while at least one of the anodes is cooled.
2. (Previously Presented) The pretreatment method according to claim 1, wherein the metal sample is at a side of the holder and a plurality of anodes face the metal sample, and at least one of the anodes is cooled for sputtering.
3. (Previously Presented) The pretreatment method according to claim 15, wherein the metal sample is at a side of the holder and a plurality of cathodes face the metal sample, and at least one of the cathodes is cooled for sputtering.
4. (Original) The pretreatment method according to claim 1, comprising analyzing an element in the metal sample selected from the group consisting of carbon, oxygen, nitrogen and sulfur.
5. (Original) The pretreatment method according to claim 2, comprising analyzing an element in the metal sample selected from the group consisting of carbon, oxygen, nitrogen and sulfur.
6. (Original) The pretreatment method according to claim 3, comprising analyzing an element in the metal sample selected from the group consisting of carbon, oxygen, nitrogen and sulfur.
7. (Original) The pretreatment method according to claim 1, wherein the element analysis of the metal sample is by fusion analysis or combustion analysis.
8. (Original) The pretreatment method according to claim 2, wherein the element analysis of the metal sample is by fusion analysis or combustion analysis.

9. (Original) The pretreatment method according to claim 3, wherein the element analysis of the metal sample is by fusion analysis or combustion analysis.

10. (Original) The pretreatment method according to claim 4, wherein the element analysis of the metal sample is by fusion analysis or combustion analysis.

11. (Original) The pretreatment method according to claim 5, wherein the element analysis of the metal sample is by fusion analysis or combustion analysis.

12. (Cancelled).

13. (Currently Amended) A pretreatment apparatus for element analysis of a metal sample, comprising:

a holder for holding a metal sample, the metal sample functioning as a cathode for sputtering;

anodes arranged in a face to face arrangement with an entire side of metal sample and on opposing sides of the metal sample;

a pretreatment chamber for storing the holder, the anodes and the metal sample under an inert gas atmosphere; and

a cooling device that performs ~~targeted~~ cooling of at least one of the anodes, the cooling device being set at a cooling temperature of approximately 50°C or below to prevent recontamination of the metal sample during sputtering.

14. (Previously Presented) The pretreatment apparatus according to claim 13, comprising a plurality of the anodes arranged to counter the metal sample, and the cooling device cools at least one of the plurality of anodes.

15. (Currently Amended) An analyzing apparatus for element analysis of a metal sample, comprising:

a holder for holding a metal sample, the metal sample functioning as an anode for sputtering;

cathodes arranged to counter the metal sample for sputtering;  
a pretreatment chamber for storing the holder, the cathodes and the metal sample under an inert gas atmosphere;  
a cooling device that compulsively performs ~~targeted~~-cooling of at least one of the cathodes;  
a reaction chamber, connected to the pretreatment chamber through a shutter, for heating the metal sample; and  
a detector for detecting trace elements given off by the heated metal sample.

16. (Previously Presented) The analyzing apparatus according to claim 15, comprising a plurality of the cathodes arranged to counter the metal sample, and the cooling device cools at least one of the plurality of cathodes.

17. (Currently Amended) An analyzing apparatus for element analysis of a metal sample, comprising:

a pretreatment chamber having means for removing contaminants on the surface of the metal sample by sputtering;

means for performing ~~targeted~~-cooling of the means for removing contaminants; and

a reaction chamber connected to the pretreatment chamber having means for heating the metal sample and means for detecting trace elements given off by the heated sample,

wherein the means for performing ~~targeted~~-cooling is set at a cooling temperature of approximately 50°C or below to prevent recontamination of the metal sample during sputtering.

18. (Previously Presented) The pretreatment apparatus according to claim 13, further comprising:

a reaction chamber, connected to the pretreatment chamber through a shutter, for heating the metal sample; and

a detector for detecting trace elements given off by the heated metal sample.

19. (Currently Amended) A pretreatment method for element analysis of a metal sample, comprising:

holding the metal sample using a holder, the metal sample functioning as a cathode;

sputtering using anodes arranged to counter the metal sample;

providing an inert gas atmosphere and a pretreatment chamber that stores the anodes, the holder, and the metal sample; and

performing ~~targeted~~ cooling of at least one of the anodes at a cooling temperature of approximately 50°C or below to prevent recontamination of the metal sample during sputtering.

20. (Currently Amended) A pretreatment apparatus for element analysis of a metal sample, comprising:

means for holding the metal sample using a holder, the metal sample functioning as a cathode;

means for sputtering using anodes arranged to counter the metal sample;

means for providing an inert gas atmosphere and a pretreatment chamber that stores the anodes, the holder, and the metal sample; and

means for performing ~~targeted~~ cooling of at least one of the anodes at a cooling temperature of approximately 50°C or below to prevent recontamination of the metal sample during sputtering.